

L Number	Hits	Search Text	DB	Time stamp
1	988	n WITH p WITH wall WITH substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/25 08:04
2	31	(n WITH p WITH wall WITH substrate) SAME conductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/25 08:05
3	21333	n WITH p WITH well WITH substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/25 08:05
4	429	(n WITH p WITH well WITH substrate) SAME conductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/25 08:39
6	6	(n WITH p WITH well WITH substrate) AND (spiral NEAR conductor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/25 08:07
8	40	((n WITH p WITH well WITH substrate) SAME conductor) AND q	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/25 08:36
9	26918	336/.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/25 08:37
10	287601	257/.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/25 08:38
11	314256	336/.ccls. OR 257/.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/25 08:38
12	273	((n WITH p WITH well WITH substrate) SAME conductor) AND (336/.ccls. OR 257/.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/25 08:39